

Application No. 09/817,473

January 20, 2004

TO:

Commissioner of Patents

P.O. Box 1435

Alexandria, VA 22313-1450

FROM:

George O. Saile, Reg. No. 19,572

28 Davis Ave.

Poughkeepsie, N.Y. 12603

SUBJECT:

Serial #:

File Date:

09/817,473 03/26/2001

Inventor:

YI, XU ET AL.

Examiner:

NGUYEN, THANH T.

Art Unit:

2813

Title:

GAP FILLING PROCESS IN INTEGRATED

CIRCUITS USING LOW DIELECTRIC CONSTANT

MATERIALS

RESPONSE TO OFFICE ACTION

This is in response to the Office Action dated October 16, 2003, Paper No. 15. Please consider the following in regards to the above referenced application.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents, P.O. Box 1435, Alexandria, VA 22313-1450 on January 30, 2004.

Signature '

Date

1/30/04

Stephen B. Ackerman, Reg. No. 37,761

TABLE OF CONTENTS:

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks begin on page 5 of this paper.